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# DESCRIPTION:

The CENTRAL SEMICONDUCTOR CMPD6263 series devices are silicon Schottky diodes designed for low current surface mount fast switching applications requiring a low forward voltage drop.



The following configurations are available:			
CMPD6263 SINGLE	MARKING CODE: D76		
CMPD6263A DUAL, COMMON ANODE	MARKING CODE: D98		
CMPD6263C DUAL, COMMON CATHODE	MARKING CODE: D97		
CMPD6263S DUAL, IN SERIES	MARKING CODE: D96		

MAXIMUM RATINGS: (T <sub>A</sub> =25°C)	SYMBOL		UNITS
Peak Repetitive Reverse Voltage	V <sub>RRM</sub>	70	V
Continuous Forward Current	١ <sub>F</sub>	15	mA
Peak Forward Surge Current, tp=1.0s	IFSM	50	mA
Power Dissipation	PD	350	mW
Operating and Storage Junction Temperature	T <sub>J</sub> , T <sub>stg</sub>	-65 to +150	°C
Thermal Resistance	$\Theta_{JA}$	357	°C/W

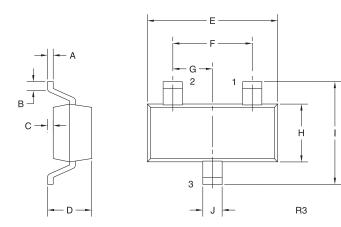
ELECTRICAL CHARACTERISTICS PER DIODE: (T <sub>A</sub> =25°C unless otherwise noted)					
SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
I <sub>R</sub>	V <sub>R</sub> =50V		10	200	nA
BVR	Ι <sub>R</sub> =10μΑ	70			V
VF	I <sub>F</sub> =1.0mA		395	410	mV
СJ	V <sub>R</sub> =0, f=1.0MHz			2.0	pF





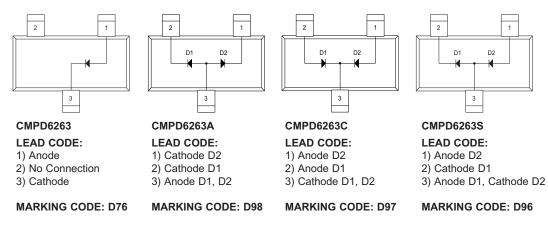
## SURFACE MOUNT SILICON SCHOTTKY DIODES

## SOT-23 CASE - MECHANICAL OUTLINE



	DIMENSIONS						
	INCHES		MILLIMETER				
SYMBOL	MIN	MAX	MIN	MAX			
А	0.003	0.007	0.08	0.18			
В	0.006	-	0.15	-			
С	-	0.005	-	0.13			
D	0.035	0.043	0.89	1.09			
Е	0.110	0.120	2.80	3.05			
F	0.075		1.	90			
G	0.037		0.	95			
Н	0.047	0.055	1.19	1.40			
	0.083	0.098	2.10	2.49			
J	0.014	0.020	0.35	0.50			
SOT-23 (REV: R3)							

**PIN CONFIGURATIONS** 

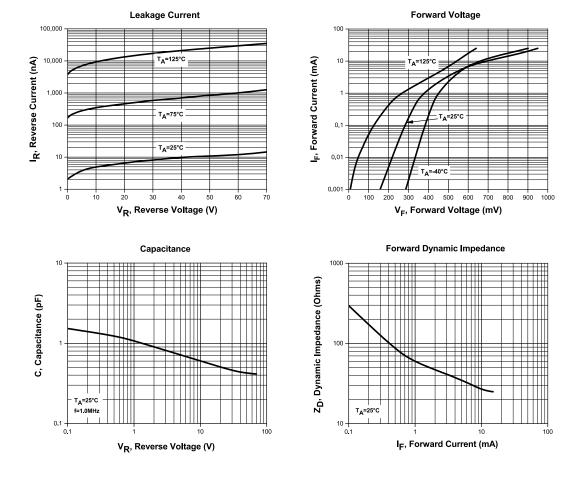


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CMPD6263 CMPD6263A CMPD6263C CMPD6263S

### SURFACE MOUNT SILICON SCHOTTKY DIODES



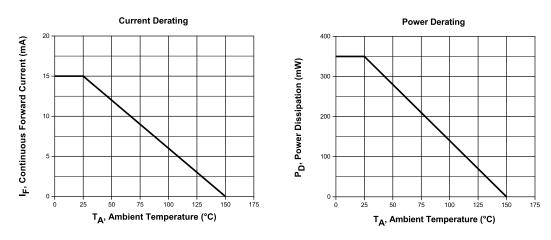
# TYPICAL ELECTRICAL CHARACTERISTICS

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SURFACE MOUNT SILICON SCHOTTKY DIODES



# TYPICAL ELECTRICAL CHARACTERISTICS

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# **OUTSTANDING SUPPORT AND SUPERIOR SERVICES**

#### **PRODUCT SUPPORT**

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- Inventory bonding
- · Consolidated shipping options

### **DESIGNER SUPPORT/SERVICES**

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free quick ship samples (2<sup>nd</sup> day air)
- Online technical data and parametric search
- SPICE models
- Custom electrical curves
- Environmental regulation compliance
- Customer specific screening
- Up-screening capabilities

Special wafer diffusions

· Custom product packing

- PbSn plating options
- Package details
- Application notes
- · Application and design sample kits

Custom bar coding for shipments

Custom product and package development

### **REQUESTING PRODUCT PLATING**

- 1. If requesting Tin/Lead plated devices, add the suffix "TIN/LEAD" to the part number when ordering (example: 2N2222A TIN/LEAD).
- If requesting Lead (Pb) Free plated devices, add the suffix "PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

### CONTACT US

### **Corporate Headquarters & Customer Support Team**

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